

USB2.0 High-Speed and Audio/USB/UART Switch with Negative Swing Capacity

Features

- Low Ron Audio/USB analog switch
- Low USB Con: 7pF
- Negative Signal Swing Capable
- Low Audio Distortion
- USB Switch -3dB Bandwidth: 1100MHz
- High Crosstalk and Off-isolation
- Voltage Supply Operation: 2.7 to 5.5V
- Three Green Packages: DQFN-10, QFN-10, MSOP-10

Applications

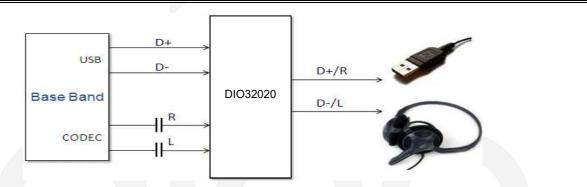
- Cell-Phone/PDA
- MP3/MP4/PMP
- Portable Instrumentation
- Battery Powered Communications
- Computer Peripherals

Block Diagram

Descriptions

The DIO32020 is dual SPDT (Single Pole/Double Throw) switch which combines low distortion audio/USB/UART and USB2.0 high-speed data signal switching in the same low voltage device. This architecture is designed to allow negative signal passing as low as 3V below ground. When a voltage is detected on V_{BUS} , DIO32020 will immediately switch to USB mode. Due to ultra low capacitance design, the audio channels (pin 3 and pin 4 input/outputs) are able to not only switch audio signal but also high speed USB signal or low voltage UART signal as well.

DIO32020 provides packages with Green or RoHS tiny 10L packages, and operates over a temperature range of -40°C to 85°C.



Ordering Information

Order Part Number	Top Marking		TA	Package		
DIO32020LP10	YW0A	Green	-40 to 85°C	DQFN-10	Tape & Reel, 3000	
DIO32020QN10	YW0A	Green	-40 to 85°C	QFN-10	Tape &Reel, 3000	
DIO32020MP10	D32020	Green	-40 to 85°C	MSOP-10	Tape &Reel, 3000	



Pin Assignment

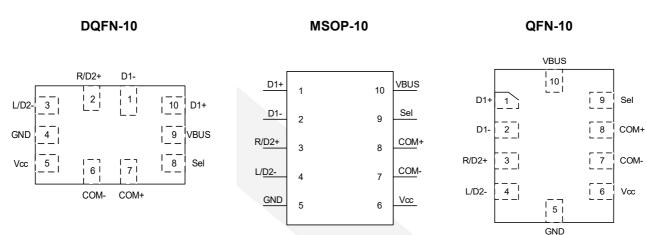


Figure 1 Top View

Pin Descriptions

Pin Name	Direction	Description
D1+, D1-	I/O	Differential USB Data Input 1
R/D2+, L/D2-	I/O Audio R/L or differential USB data	
V _{BUS}		Switch Select
COM+/COM-	I/O	Data/Audio Common Port
Sel	l	Control Input
Vcc/ GND	Р	Power

Truth Table

Sel	V _{BUS}	L/D2-, R/D2+	D1+, D1-	
Low	Low Low		OFF	
Low	High	OFF	ON	
High	High X		OFF	



Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Rating" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Symbol	Parameter		Rating	Unit		
V _{cc}	Supply Voltage		-0.5 to 6.5	V		
V _{BUS}	V _{BUS} Control Input Voltage		-0.5 to 6.5	V		
V _{IN}	A _{SEL} Control Input Voltage		-0.5 to 6.5	V		
	USB Path Analog Signal Voltag	e	-0.5 to 6.5			
V _{sw}	Audio Path Analog Signal Voltage		-3.5 to 6.5	V		
	Storage Temperature		-65 to 150	°C		
	A _{SEL} Control Input Current		5			
l _{iN}	V _{BUS} Control Input Current		5	μΑ		
I _{sw_con}	Analog Signal Continuous Current		Analog Signal Continuous Current ±100		±100	mA
I _{SW_PK}	Analog Signal Peak Current		±500	mA		
ESD.		I/O to GND	5			
ESD	HBM, JEDEC: JESD22-A114	Others	8	kV		

Recommend Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended Operating conditions are specified to ensure optimal performance to the datasheet specifications. DIOO does not Recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Rating	Unit	
V _{cc}	Supply Voltage	2.7 to 5.5	V	
N	V _{BUS} Control Input Voltage	0 to 5.5	V	
V _{IN}	A _{SEL} Control Input Voltage	0 to V _{cc}	v	
	USB to COM Analog Signal Voltage	0 to V _{CC}	V	
V _{sw}	Audio to COM Analog Signal Voltage	-3 to V_{CC}	v	
T _A Operating Temperature Range		-40 to 85	°C	



DC Electrical Characteristics

All typical value are at T_A = 25°C unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit		
CONTROL	CONTROL INPUT (T _A =25°C, V _{CC} =3.3V)							
V _{IH}	A _{SEL} Control Input High Voltage	V _{cc} =2.7-4.2V	1.3			V		
V _{IL}	A _{SEL} Control Input Low Voltage	V _{CC} =2.7-4.2V			0.5	V		
l _{IN}	A _{SEL} Control Input Leakage Current	0≤V _{sw} ≤V _{cc}		1	2	μΑ		
V _{IH}	V _{BUS} Control Input High Voltage	V _{cc} =2.7-4.2V	1.3			V		
VIL	V _{BUS} Control Input Low Voltage	V _{cc} =2.7-4.2V			0.5	V		
I _{IN}	V _{BUS} Control Input Leakage Current	0≤V _{sw} ≤V _{cc}		1	2	μA		
R _{VBUS_PD}	V _{BUS_CTRL} Pull down Resistance	I _{ON} =10mA		4000		kΩ		
SUPPLY C	SUPPLY CURRENT AND LEAKAGE (T _A =25°C, V _{CC} =3.3V)							
I _{OZ-USB}	Off Leakage Current of port DN/DP	DN/DP=0V to 4.2V, R, L, COM+, COM- float	-1		1	uA		
I _{OZ-AUDIO}	Off Leakage Current of port R/L	R/L=-3V to 3V, DN, DP, COM+, COM- float	-1		1	uA		
I _{ON-USB}	On Leakage Current of USB Switch	COM+/COM- =0V to 4.2V, R, L, DN, DP float	-1		1	uA		
I _{ON-AUDIO}	On Leakage Current of AUDIO Switch	COM+/COM- =-3V to 3V, R, L, DN, DP float	-1		1	uA		
l _{off}	Power off leakage	V _{cc} =0V	-1		1	uA		
I _{cc}	Quiescent Supply			18	35	μA		
USB SWIT	CHES (D+, D-) (T _A =25°C, V ₀	_{CC} =3.3V)						
R _{ON}	On Resistance	I_{ON} =10mA, V_{SW} =0V to V_{CC}		3.8		Ω		
R _{FLATE}	On Resistance Flatness	I_{ON} =10mA, V_{SW} =0V to V_{CC}		15		mΩ		
ΔR_{ON}	On Resistance Matching	I_{ON} =10mA, V_{SW} =0V to V_{CC}		100		mΩ		
AUDIO SW	AUDIO SWITCHES (R, L) ($T_A=25^{\circ}C$, $V_{CC}=3.3V$)							
R _{on}	On Resistance	I_{ON} =100mA, V _{SW} =-3 to 3V		0.8		Ω		
R _{FLATE}	On Resistance Flatness	I _{ON} =100mA, V _{SW} =-3 to 3V		2		mΩ		
ΔR_{ON}	On Resistance Matching	I_{ON} =100mA, V _{SW} =-3 to 3V		50		mΩ		



Electrical Characteristics (Continued)

All typical value are at T_A =25°C unless otherwise specified.

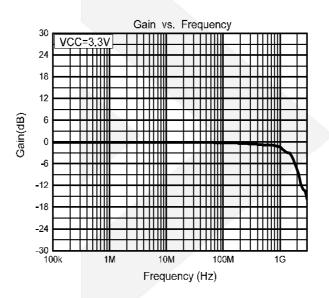
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit		
AC Parameter (T_A =25°C, V_{CC} =3.3V, R_L =50 Ω , C_L =5pF, unless otherwise specified)								
	USB Turn-on Time	DP=DN=1.5V, R_L =50 Ω , C_L =35pF		32		μs		
t _{on}	Audio Turn-on Time	L=R=1.5V, R _L =50 Ω , C _L =35pF		32		μs		
	USB Turn-off Time	DP=DN=1.5V, R_L =50 Ω , C_L =35pF		100		ns		
t _{OFF}	Audio Turn-off Time	L=R=1.5V, R _L =50Ω, C _L =35pF		150		ns		
		Audio off to USB on		30		μs		
Т _{ввм}	Break Before Make Time	USB off to Audio on		30		μs		
BW	-3dB Bandwidth USB Channel	R _L =50Ω, C _L =5pF		1100		MHz		
	USB OFF-Isolation	V_{SW} =1 V_{RMS} , R_L =50 Ω , f=240MHz		-23		dB		
OIRR	Audio OFF-Isolation	V_{SW} =1 V_{RMS} , R_L =50 Ω , f=1kHz		-110		dB		
	USB Crosstalk	R _L =50Ω, f=240MHz		-45		dB		
Xtalk	Audio Crosstalk	R∟=50Ω, f=1kHz		-80		dB		
	Total Harmonic Distortion + Noise	R_L =600 Ω , f=1kHz, V _{SW} =2V _{RMS} , With A-weighted		-110				
THD+N		R _L =32Ω, f=1kHz, V _{sw} =1V _{RMS} , With A-weighted		-100		dB		
		R _L =16Ω, f=1kHz, V _{SW} =0.5V _{RMS} , With A-weighted		-100				
PSRR	Power Supply Rejection Ratio	f=10kHz, R _{COM} =50Ω		-75		dB		
CAPACITANCE (T _A =25°C, V _{CC} =3.3V, R _L =50 Ω , C _L =5pF, f=1MHz, A _{SEL} =0V, unless otherwise specified)								
C _{IN}	A _{SEL} Control Input Capacitance	V _{CC} = 0V		2		pF		
C _{ON}	USB ON Capacitance	f=1MHz, V_{BUS} =VDD, V_{SEL} =LOW, V_{D} or V_{D+} = V_{COMX} = 0V		7		pF		



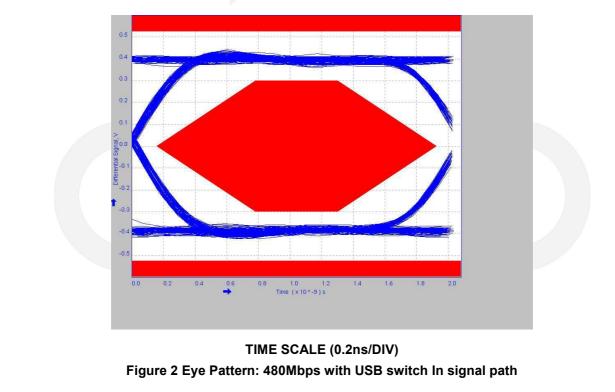
C _{ON}	Audio ON Capacitance	V _{BUS} =LOW, V _{SEL} =LOW	7	pF
C_{OFF}	USB OFF Capacitance	V _{BUS} =VDD, V _{SEL} =LOW	3	pF
C _{OFF}	Audio OFFCapacitance	V _{BUS} =LOW, V _{SEL} =LOW	4	pF

Typical Performance Characteristics

 T_A =25°C, Vcc=3.3V, unless other otherwise specified.

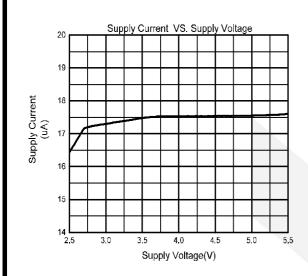


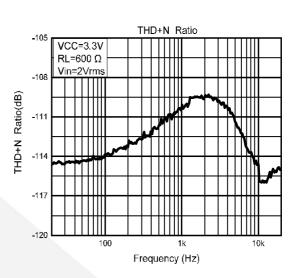
DIO32020 USB 2.0 high speed (480Mbps) eye pattern



USB2.0 High-Speed and Audio Switch with Negative Swing Capacity







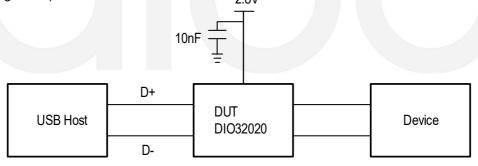
Applications Design Guide

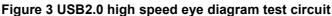
DIO32020 is used in applications where the slim and thin smart phone designs are expected. By sharing the USB connector between USB2.0 data lines and audio headphone outputs, the designers can eliminate the using of bulky headphone jacks. Meanwhile, using the mini-USB connectors as audio outputs allows the end users to reduce the cost to buy too many different types of cell phone accessories.

DIO32020 unique architectures allow the part to allow the part to have constant Ron, Ron (flatness) and THD performance independent of Vcc supply value. So in some applications such as mobile cell phone designs, if the designers want to achieve the lowest standby power consumption when the battery is turned OFF, it is highly recommended that DIO32020 be powered by 2.8V, no need of being powered by battery (4.3V) directly. This will help designers to be freed from the complex logic designs to ensure the part will get into sleep mode.

DIO32020's control pins are 1.8V control logic compatible, so the parts can be controlled by baseband processor GPIO directly without worrying about the level shifting issues. Regarding high speed signal integrity, DIO32020 is recommended to be placed as close as possible to the USB controller outputs to reduce the signal reflection under high speed mode (480Mbps). In the meanwhile, the Vcc pin of DIO32020 is required to have decoupling capacitors to reduce the supply ripples.

The below is the DIO32020 USB 2.0 high speed (480Mbps) eye diagram compliance test under near-end mode (most challenging mode). 2.8







DIO32020 features not only 100dB total harmonic distortion (THD), but also superior off isolation capability. When DIO32020 is powered under audio mode, audio channel can pass at least -3V negative audio signal with up to 100dB THD performance. Under USB mode or device being powered OFF(V_{CC}=0), the negative audio signal on audio ports can be isolated as well to allow flexible design needs.



CONTACT US

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